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SNx4LV86A Quadruple 2-Input Exclusive-OR Gates

Technical

Documents

1 Features

- 2-V to 5.5-V V_{CC} Operation
- Max t_{pd} of 8 ns at 5 V
- Typical V_{OLP} (Output Ground Bounce) <0.8 V at $V_{CC} = 3.3 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$
- Typical V_{OHV} (Output V_{OH} Undershoot) >2.3 V at $V_{CC} = 3.3 \text{ V}, \text{ T}_{A} = 25^{\circ}\text{C}$
- Support Mixed-Mode Voltage Operation on All Ports
- Latch-Up Performance Exceeds 250 mA per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)

Applications 2

- EPOS •
- Programmable Logic Controller (PLC)
- DCS and PAC: Analog Input Module
- Medical Meters: Portable
- Server Motherboard
- Printer

4 Simplified Schematic

= 1

These are five equivalent exclusive-OR symbols valid for an 'LV86A gate in positive logic; negation can be shown at Α. any two ports. See Functional Block Diagram for more information.

3 Description

Tools &

Software

The 'LV86A devices are quadruple 2-input exclusive-OR gates designed for 2-V to 5.5-V V_{CC} operation.

Support &

Community

20

These devices contain four independent 2-input exclusive-OR gates. They perform the Boolean function $Y = A \oplus B$ or $Y = \overline{AB} + A\overline{B}$ in positive logic.

A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

| Device | Inform | ation ⁽¹⁾ |
|--------|--------|----------------------|
|--------|--------|----------------------|

| PART NUMBER | PACKAGE | BODY SIZE (NOM) | | | |
|-------------|------------|--------------------|--|--|--|
| | VQFN (14) | 3.50 mm × 3.50 mm | | | |
| | SOIC (14) | 8.65 mm × 3.91 mm | | | |
| LV86A | SOP (14) | 10.30 mm × 5.30 mm | | | |
| | SSOP (14) | 6.20 mm × 5.30 mm | | | |
| | TSSOP (14) | 5.00 mm × 4.40 mm | | | |

(1) For all available packages, see the orderable addendum at the end of the data sheet.



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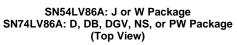
| Ch | anges from Revision F (April 2005) to Revision G Pa | | | | |
|----|---|---|--|--|--|
| • | Added ESD Ratings table, Feature Description section, Device Functional Modes, Application and Implementation section, Power Supply Recommendations section, Layout section, Device and Documentation Support section, and Mechanical, Packaging, and Orderable Information section | 1 | | | |

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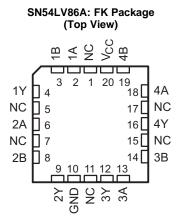
2



6 Pin Configuration and Functions



| 1A [] 1 1B [] 2 | 14 V _{CC} 13 4B |
|-------------------------------|-----------------------------|
| 1B 🚺 2 | 13 🛛 4B |
| 1Y 🛛 3 | 12 🛛 4A |
| 2A 🛛 4 | 11 🛛 4Y |
| 2B 🚺 5 | 10 🛛 3B |
| 2Y 🛿 6 | 9 🛛 3A |
| GND 7 | 8 3Y |
| 2A 4 2B 5 2Y 6 GND 7 | 10] 3B 9] 3A |



B. NC – No internal connection

Pin Functions

| PIN | I/O | DESCRIPTION |
|-----|-----------------|-------------|
| 1 | 1A | A input 1 |
| 2 | 1B | B input 1 |
| 3 | 1Y | Output 1 |
| 4 | 2A | A input 2 |
| 5 | 2B | B input 2 |
| 6 | 2Y | Output 2 |
| 7 | GND | ground |
| 8 | 3Y | Output 3 |
| 9 | 3A | A input 3 |
| 10 | 3B | B input 3 |
| 11 | 4Y | Output 4 |
| 12 | 4A | A input 4 |
| 13 | 4B | B input 4 |
| 14 | V _{CC} | Power pin |

TEXAS INSTRUMENTS

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7 Specifications

7.1 Absolute Maximum Ratings

over operating free-air temperature range (unless otherwise noted) ⁽¹⁾

| | | MIN | MAX | UNIT |
|------------------|---|------|-------------------------|------|
| V _{CC} | Supply voltage | -0.5 | 7 | V |
| VI | Input voltage ⁽²⁾ | -0.5 | 7 | V |
| Vo | Voltage applied to any output in the high-impedance or power-off state $^{(2)}$ | -0.5 | 7 | V |
| Vo | Output voltage ⁽²⁾⁽³⁾ | -0.5 | V _{CC} + 0.5 V | V |
| I _{IK} | Input clamp current, V _I < 0 | | -20 | mA |
| I _{OK} | Output clamp current, V _O < 0 | | -50 | mA |
| Io | Continuous output current, $V_O = 0$ to V_{CC} | -25 | 25 | mA |
| | Continuous current through V _{CC} or GND | -50 | 50 | mA |
| T _{stg} | Storage temperature | -65 | 150 | °C |

(1) Stresses beyond those listed under Absolute Maximum Ratings may cause permanent damage to the device. These are stress ratings only, which do not imply functional operation of the device at these or any other conditions beyond those indicated under Recommended Operating Conditions. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

(3) This value is limited to 5.5-V maximum.

7.2 ESD Ratings

| | | | VALUE | UNIT |
|--------|---------------|--|-------|------|
| V | Electrostatic | Human-body model (HBM), per ANSI/ESDA/JEDEC JS-001 ⁽¹⁾ | 2000 | V |
| V(ESD) | discharge | Charged-device model (CDM), per JEDEC specification JESD22-C101 ⁽²⁾ | 1000 | v |

(1) JEDEC document JEP155 states that 500-V HBM allows safe manufacturing with a standard ESD control process.

(2) JEDEC document JEP157 states that 250-V CDM allows safe manufacturing with a standard ESD control process.

4

⁽²⁾ The input and output negative-voltage ratings may be exceeded if the input and output current ratings are observed.



7.3 Recommended Operating Conditions

| see (1) | |
|---------|--|
| | |

| | | | MIN | MAX | UNIT |
|-----------------|------------------------------------|----------------------------------|-----------------------|---------------------|------|
| V _{CC} | Supply voltage | | 2 | 5.5 | V |
| | | $V_{CC} = 2 V$ | 1.5 | | N |
| V | | V_{CC} = 2.3 V to 2.7 V | V _{CC} × 0.7 | | |
| VIH | High-level input voltage | $V_{CC} = 3 V \text{ to } 3.6 V$ | V _{CC} × 0.7 | | V |
| | | V_{CC} = 4.5 V to 5.5 V | V _{CC} × 0.7 | | |
| | | $V_{CC} = 2 V$ | | 0.5 | |
| V | Low-level input voltage | V_{CC} = 2.3 V to 2.7 V | | $V_{CC} \times 0.3$ | V |
| V _{IL} | Low-level input voltage | $V_{CC} = 3 V \text{ to } 3.6 V$ | | $V_{CC} \times 0.3$ | v |
| | | V_{CC} = 4.5 V to 5.5 V | | $V_{CC} \times 0.3$ | |
| VI | Input voltage | | 0 | 5.5 | V |
| Vo | Output voltage | | 0 | V _{CC} | V |
| | | $V_{CC} = 2 V$ | | -50 | μA |
| | Ligh lovel output ourrest | V_{CC} = 2.3 V to 2.7 V | | -2 | mA |
| I _{OH} | High-level output current | $V_{CC} = 3 V \text{ to } 3.6 V$ | | -6 | |
| | | V_{CC} = 4.5 V to 5.5 V | | -12 | |
| | | $V_{CC} = 2 V$ | | 50 | μA |
| | Low-level output current | V_{CC} = 2.3 V to 2.7 V | | 2 | |
| I _{OL} | | $V_{CC} = 3 V \text{ to } 3.6 V$ | | 6 | mA |
| | | V_{CC} = 4.5 V to 5.5 V | | 12 | |
| Δt/Δv | | V_{CC} = 2.3 V to 2.7 V | | 200 | |
| | Input transition rise or fall rate | $V_{CC} = 3 V \text{ to } 3.6 V$ | | 100 | ns/V |
| | | V_{CC} = 4.5 V to 5.5 V | | 20 | |
| T _A | Operating free-air temperature | | -55 | 125 | °C |

(1) All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, SCBA004.

7.4 Thermal Information

| THERMAL METRIC ⁽¹⁾ | | D | DB | DGV | NS | PW | UNIT |
|-------------------------------|---|------|-------|---------|------|-------|------|
| | | | | 14 PINS | | | UNIT |
| $R_{\theta JA}$ | Junction-to-ambient thermal resistance ⁽²⁾ | 90.6 | 107.1 | 129.0 | 90.7 | 122.6 | |
| R _{0JC(top)} | Junction-to-case (top) thermal resistance | 50.9 | 59.6 | 52.1 | 48.3 | 51.4 | |
| $R_{\theta JB}$ | Junction-to-board thermal resistance | 44.8 | 54.4 | 62.0 | 49.4 | 64.4 | °C/W |
| Ψ _{JT} | Junction-to-top characterization parameter | 14.7 | 20.5 | 6.5 | 14.6 | 6.7 | |
| Ψ_{JB} | Junction-to-board characterization parameter | 44.5 | 53.8 | 61.3 | 49.1 | 63.8 | |

(1) For more information about traditional and new thermal metrics, see the IC Package Thermal Metrics application report, SPRA953.

(2) The package thermal impedance is calculated in accordance with JESD 51-7.

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7.5 Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

| PARAMETER | TEST CONDITIONS | V _{cc} | SN | 54LV86A | | - | 74LV86A C to 125°C | | UNIT |
|------------------|--------------------------------------|-----------------|----------------|---------|------|-----------------------|-----------------------|------|------|
| | | | MIN | TYP | MAX | MIN | TYP | MAX | |
| | I _{OH} = -50 μA | 2 to 5.5 V | $V_{CC} - 0.1$ | | | V _{CC} – 0.1 | | | |
| N/ | $I_{OH} = -2 \text{ mA}$ | 2.3 V | 2 | | | 2 | | | V |
| V _{OH} | I _{OH} =6 mA | 3 V | 2.48 | | | 2.48 | | | V |
| | I _{OH} = -12 mA | 4.5 V | 3.8 | | | 3.8 | | | |
| | I _{OL} = 50 μA | 2 to 5.5 V | | | 0.1 | | | 0.1 | |
| N/ | $I_{OL} = 2 \text{ mA}$ | 2.3 V | | | 0.4 | | | 0.4 | V |
| V _{OL} | I _{OL} = 6 mA | 3 V | | | 0.44 | | | 0.44 | V |
| | I _{OL} = 12 mA | 4.5 V | | | 0.55 | | | 0.55 | |
| li . | $V_{I} = 5.5 V \text{ or GND}$ | 0 to 5.5 V | | | ±1 | | | ±1 | μA |
| I _{CC} | $V_{I} = V_{CC}$ or GND, $I_{O} = 0$ | 5.5 V | | | 20 | | | 20 | μA |
| I _{off} | V_{I} or V_{O} = 0 to 5.5 V | 0 | | | 5 | | | 5 | μA |
| C _i | $V_{I} = V_{CC}$ or GND | 3.3 V | | 1.4 | | | 1.4 | | pF |

7.6 Switching Characteristics, $V_{cc} = 2.5 \text{ V} \pm 0.2 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER | FROM (INPUT) | TO (OUTPUT) | | | T _A = 25°C | | | МАХ | UNIT |
|-------------|--------------|-------------|------------------------|-----|-----------------------|---------------------|------------------|-------------------|------|
| FARAINETER | | 10 (001-01) | CAPACITANCE | MIN | TYP | MAX | MIN | IVIAA | UNIT |
| | A or D | V | C _L = 15 pF | | 7.9 ⁽¹⁾ | 17.6 ⁽¹⁾ | 1 ⁽²⁾ | 21 ⁽²⁾ | |
| l pd | A or B | ř | C _L = 50 pF | | 10.5 | 22.6 | 1 | 26.5 | ns |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

(2) This note applies to SN54LV86A only: On products compliant to MIL-PRF-38535, this parameter is not production tested.

7.7 Switching Characteristics, $V_{CC} = 3.3 \text{ V} \pm 0.3 \text{ V}$

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER | | | LOAD | T, | _A = 25°C | | MIN | МАХ | UNIT |
|-----------|--------------|-------------|------------------------|-----|---------------------|-------------------|------------------|-------------------|------|
| PARAMETER | FROM (INPUT) | TO (OUTPUT) | CAPACITANCE | MIN | TYP | MAX | IVIIIN | WAA | UNIT |
| | A or D | V | C _L = 15 pF | | 5.5 ⁽¹⁾ | 11 ⁽¹⁾ | 1 ⁽²⁾ | 13 ⁽²⁾ | |
| чpd | A or B | ř | C _L = 50 pF | | 7.4 | 14.5 | 1 | 16.5 | ns |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

(2) This note applies to SN54LV86A only: On products compliant to MIL-PRF-38535, this parameter is not production tested.

7.8 Switching Characteristics, $V_{CC} = 5 V \pm 0.5 V$

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 3)

| PARAMETER | | | | T _A = 25°C | | | MIN | MAX | UNIT |
|-----------------|--------------|-------------|------------------------|-----------------------|--------------------|--------------------|------------------|------------------|------|
| PARAMETER | FROM (INPUT) | 10 (001901) | CAPACITANCE | MIN | TYP | MAX | MIN | MAX | |
| | A or B | V | C _L = 15 pF | | 3.7 ⁽¹⁾ | 6.8 ⁽¹⁾ | 1 ⁽²⁾ | 8 ⁽²⁾ | |
| ^L pd | AUB | ř | C _L = 50 pF | | 5.3 | 8.8 | 1 | 10 | ns |

(1) On products compliant to MIL-PRF-38535, this parameter is not production tested.

(2) This note applies to SN54LV86A only: On products compliant to MIL-PRF-38535, this parameter is not production tested.



7.9 Noise Characteristics for SN74LV86A

 V_{CC} = 3.3 V, C_{L} = 50 pF, T_{A} = 25°C (see ⁽¹⁾)

| | PARAMETER | MIN | TYP | MAX | UNIT |
|--------------------|---|------|------|------|------|
| V _{OL(P)} | Quiet output, maximum dynamic V _{OL} | | 0.2 | 0.8 | |
| V _{OL(V)} | Quiet output, minimum dynamic V _{OL} | | -0.1 | -0.8 | |
| V _{OH(V)} | Quiet output, minimum dynamic V _{OH} | | 3.1 | | V |
| V _{IH(D)} | High-level dynamic input voltage | 2.31 | | | |
| V _{IL(D)} | Low-level dynamic input voltage | | | 0.99 | |

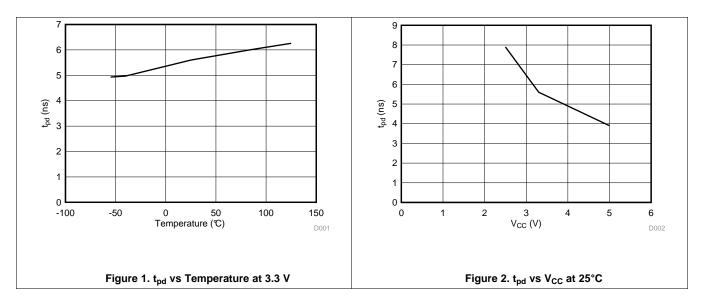
(1) Characteristics are for surface-mount packages only.

7.10 Operating Characteristics

$T_A = 25^{\circ}C$

| | PARAMETER | TEST CONDITIONS | Vcc | TYP | UNIT |
|-----------------|-------------------------------|---|-----|------------|------|
| | | 3.3 V | 8.4 | ~ C | |
| C _{pd} | Power dissipation capacitance | $C_{L} = 50 \text{ pF}, f = 10 \text{ MHz}$ | 5 V | 8.8 | pF |

7.11 Typical Characteristics

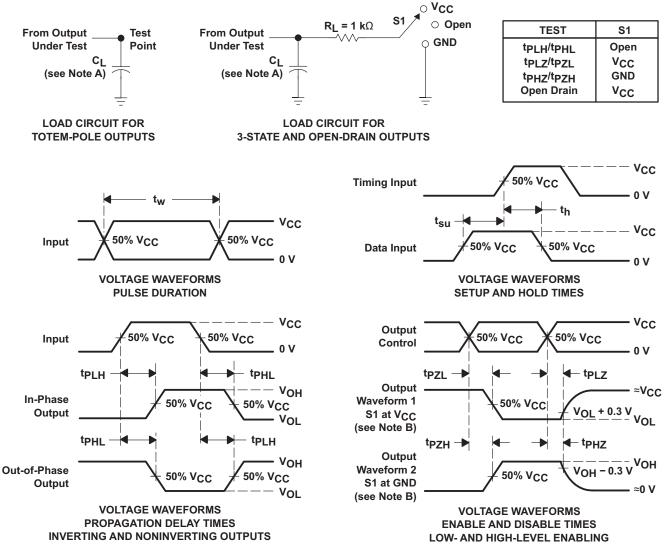


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8 Parameter Measurement Information



- A. C_L includes probe and jig capacitance.
- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 1 MHz, Z_O = 50 Ω , t_r \leq 3 ns, t_f \leq 3 ns.
- D. The outputs are measured one at a time, with one input transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en}.
- G. t_{PHL} and t_{PLH} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 3. Load Circuit and Voltage Waveforms

8



9 Detailed Description

9.1 Overview

The 'LV86A devices are quadruple 2-input exclusive-OR gates designed for 2-V to 5.5-V V_{CC} operation.

These devices contain four independent 2-input exclusive-OR gates. They perform the Boolean function $Y = A \oplus B$ or $Y = \overline{AB} + A\overline{B}$ in positive logic.

A common application is as a true/complement element. If one of the inputs is low, the other input is reproduced in true form at the output. If one of the inputs is high, the signal on the other input is reproduced inverted at the output.

9.2 Functional Block Diagram

An exclusive-OR gate has many applications, some of which can be represented better by alternative logic symbols.



A. These are five equivalent exclusive-OR symbols valid for an 'LV86A gate in positive logic; negation can be shown at any two ports.



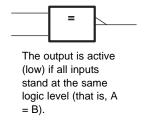
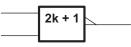


Figure 5. Logic-Identity Element



The output is active (low) if an even number of inputs (that is, 0 or 2) are active.

Figure 6. Even-Parity Element



The output is active (high) if an odd number of inputs (that is, only 1 of the 2) are active.

Figure 7. Odd-Parity Element

9.3 Feature Description

- Wide operating voltage range, operates from 2 to 5.5 V
- Allows down voltage translation, inputs accept voltages to 5.5 V

9.4 Device Functional Modes

| Table 1. Function Table (Each Gate) | | | | | | | |
|--|--------|--|--|--|--|--|--|
| INPUTS | OUTPUT | | | | | | |

| INP | UTS | OUTPUT |
|-----|-----|--------|
| Α | В | Y |
| L | L | L |
| L | Н | Н |
| Н | L | Н |
| Н | Н | L |

STRUMENTS

10 Application and Implementation

NOTE

Information in the following applications sections is not part of the TI component specification, and TI does not warrant its accuracy or completeness. TI's customers are responsible for determining suitability of components for their purposes. Customers should validate and test their design implementation to confirm system functionality.

10.1 Application Information

The SN74LV86A is a low drive CMOS device that can be used for a multitude of bus interface type applications where output ringing is a concern. The low drive and slow edge rates will minimize overshoot and undershoot on the outputs. The inputs can accept voltages to 5.5 V at any valid V_{CC} making it Ideal for down translation.

10.2 Typical Application

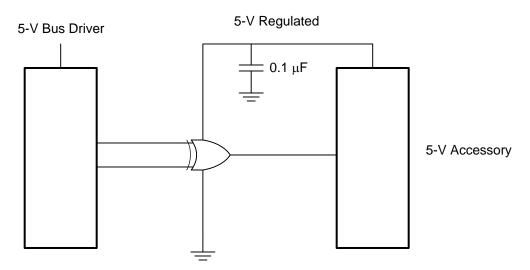


Figure 8. Typical Application Schematic

10.2.1 Design Requirements

This device uses CMOS technology and has balanced output drive. Care should be taken to avoid bus contention because it can drive currents that would exceed maximum limits. The high drive will also create fast edges into light loads so routing and load conditions should be considered to prevent ringing.

10.2.2 Detailed Design Procedure

- 1. Recommended Input conditions
 - Rise time and fall time specs see ($\Delta t/\Delta V$) in *Recommended Operating Conditions*.
 - Specified High and low levels. See (V_{IH} and V_{IL}) in *Recommended Operating Conditions*.
- 2. Recommend output conditions
 - Load currents should not exceed 25 mA per output and 50 mA total for the part
 - Outputs should not be pulled above V_{CC}



Typical Application (continued)

10.2.3 Application Curve

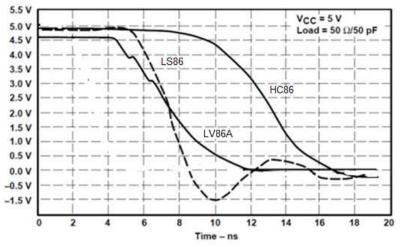


Figure 9. Switching Characteristics Comparison

11 Power Supply Recommendations

The power supply can be any voltage between the minimum and maximum supply voltage rating located in *Recommended Operating Conditions*.

Each V_{CC} terminal should have a good bypass capacitor to prevent power disturbance. For devices with a single supply, TI recommends 0.1 μ F and if there are multiple V_{CC} terminals then .01 or .022 μ F is recommended for each power terminal. It is okay to parallel multiple bypass capacitors to reject different frequencies of noise. A 0.1 μ F and 1 μ F are commonly used in parallel. The bypass capacitor should be installed as close to the power terminal as possible for best results.

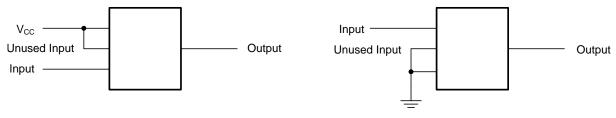
12 Layout

12.1 Layout Guidelines

When using multiple bit logic devices inputs should not ever float.

In many cases, functions or parts of functions of digital logic devices are unused, for example, when only two inputs of a triple-input AND gate are used or only 3 of the 4 buffer gates are used. Such input pins should not be left unconnected because the undefined voltages at the outside connections result in undefined operational states. Specified below are the rules that must be observed under all circumstances. All unused inputs of digital logic devices must be connected to a high or low bias to prevent them from floating. The logic level that should be applied to any particular unused input depends on the function of the device. Generally they will be tied to GND or V_{CC} whichever make more sense or is more convenient. It is generally okay to float outputs unless the part is a transceiver. If the transceiver has an output enable pin it will disable the outputs section of the part when asserted. This will not disable the input section of the IOs so they also cannot float when disabled.

12.2 Layout Example





13 Device and Documentation Support

13.1 Related Links

The table below lists quick access links. Categories include technical documents, support and community resources, tools and software, and quick access to sample or buy.

| PARTS | PRODUCT FOLDER | PRODUCT FOLDER SAMPLE & BUY TECH | | TOOLS & SOFTWARE | SUPPORT & COMMUNITY |
|-----------|----------------|----------------------------------|------------|---------------------|------------------------|
| SN54LV86A | Click here | Click here | Click here | Click here | Click here |
| SN74LV86A | Click here | Click here | Click here | Click here | Click here |

Table 2. Related Links

13.2 Trademarks

All trademarks are the property of their respective owners.

13.3 Electrostatic Discharge Caution



These devices have limited built-in ESD protection. The leads should be shorted together or the device placed in conductive foam during storage or handling to prevent electrostatic damage to the MOS gates.

13.4 Glossary

SLYZ022 — TI Glossary.

This glossary lists and explains terms, acronyms, and definitions.

14 Mechanical, Packaging, and Orderable Information

The following pages include mechanical, packaging, and orderable information. This information is the most current data available for the designated devices. This data is subject to change without notice and revision of this document. For browser-based versions of this data sheet, refer to the left-hand navigation.





PACKAGING INFORMATION

| Orderable Device | Status (1) | Package Type | Package Drawing | Pins | Package Qty | Eco Plan (2) | Lead finish/ Ball material | MSL Peak Temp | Op Temp (°C) | Device Marking (4/5) | Samples |
|------------------|---------------|--------------|--------------------|------|----------------|-----------------|-------------------------------|--------------------|--------------|-------------------------|---------|
| | (.) | | 0 | | | (=) | (6) | (0) | | (,,,,) | |
| SN74LV86ADBR | ACTIVE | SSOP | DB | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | LV86A | Samples |
| SN74LV86ADGVR | ACTIVE | TVSOP | DGV | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | LV86A | Samples |
| SN74LV86ADR | ACTIVE | SOIC | D | 14 | 2500 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 125 | LV86A | Samples |
| SN74LV86ANSR | ACTIVE | SO | NS | 14 | 2000 | RoHS & Green | NIPDAU | Level-1-260C-UNLIM | -40 to 125 | 74LV86A | Samples |
| SN74LV86APWR | ACTIVE | TSSOP | PW | 14 | 2000 | RoHS & Green | NIPDAU SN | Level-1-260C-UNLIM | -40 to 125 | LV86A | Samples |

⁽¹⁾ The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

⁽²⁾ RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

⁽³⁾ MSL, Peak Temp. - The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.

⁽⁴⁾ There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.

⁽⁵⁾ Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.

⁽⁶⁾ Lead finish/Ball material - Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.



PACKAGE OPTION ADDENDUM

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OTHER QUALIFIED VERSIONS OF SN74LV86A :

- Automotive : SN74LV86A-Q1
- Enhanced Product : SN74LV86A-EP

NOTE: Qualified Version Definitions:

- Automotive Q100 devices qualified for high-reliability automotive applications targeting zero defects
- Enhanced Product Supports Defense, Aerospace and Medical Applications



Texas

STRUMENTS

TAPE AND REEL INFORMATION





QUADRANT ASSIGNMENTS FOR PIN 1 ORIENTATION IN TAPE



| *All dimensions are nominal | | | | | | | | | | | | |
|-----------------------------|-----------------|--------------------|----|------|--------------------------|--------------------------|------------|------------|------------|------------|-----------|------------------|
| Device | Package Type | Package Drawing | | SPQ | Reel Diameter (mm) | Reel Width W1 (mm) | A0 (mm) | B0 (mm) | K0 (mm) | P1 (mm) | W (mm) | Pin1 Quadrant |
| SN74LV86ADBR | SSOP | DB | 14 | 2000 | 330.0 | 16.4 | 8.35 | 6.6 | 2.4 | 12.0 | 16.0 | Q1 |
| SN74LV86ADGVR | TVSOP | DGV | 14 | 2000 | 330.0 | 12.4 | 6.8 | 4.0 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.6 | 9.3 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 330.0 | 16.4 | 6.5 | 9.0 | 2.1 | 8.0 | 16.0 | Q1 |
| SN74LV86ANSR | SO | NS | 14 | 2000 | 330.0 | 16.4 | 8.2 | 10.5 | 2.5 | 12.0 | 16.0 | Q1 |
| SN74LV86APWR | TSSOP | PW | 14 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |
| SN74LV86APWR | TSSOP | PW | 14 | 2000 | 330.0 | 12.4 | 6.9 | 5.6 | 1.6 | 8.0 | 12.0 | Q1 |



PACKAGE MATERIALS INFORMATION

17-Mar-2024



| Device | Package Type | Package Drawing | Pins | SPQ | Length (mm) | Width (mm) | Height (mm) |
|---------------|--------------|-----------------|------|------|-------------|------------|-------------|
| SN74LV86ADBR | SSOP | DB | 14 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LV86ADGVR | TVSOP | DGV | 14 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 356.0 | 356.0 | 35.0 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 366.0 | 364.0 | 50.0 |
| SN74LV86ADR | SOIC | D | 14 | 2500 | 356.0 | 356.0 | 35.0 |
| SN74LV86ANSR | SO | NS | 14 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LV86APWR | TSSOP | PW | 14 | 2000 | 356.0 | 356.0 | 35.0 |
| SN74LV86APWR | TSSOP | PW | 14 | 2000 | 356.0 | 356.0 | 35.0 |

MECHANICAL DATA

PLASTIC SMALL-OUTLINE PACKAGE

0,51 0,35 ⊕0,25⊛ 1,27 8 14 0,15 NOM 5,60 8,20 5,00 7,40 \bigcirc Gage Plane ₽ 0,25 7 1 1,05 0,55 0°-10° Δ 0,15 0,05 Seating Plane — 2,00 MAX 0,10PINS ** 14 16 20 24 DIM 10,50 10,50 12,90 15,30 A MAX A MIN 9,90 9,90 12,30 14,70 4040062/C 03/03

NOTES: A. All linear dimensions are in millimeters.

NS (R-PDSO-G**)

14-PINS SHOWN

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15.



MECHANICAL DATA

PLASTIC SMALL-OUTLINE

MPDS006C - FEBRUARY 1996 - REVISED AUGUST 2000

DGV (R-PDSO-G**)

24 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

B. This drawing is subject to change without notice.

- C. Body dimensions do not include mold flash or protrusion, not to exceed 0,15 per side.
- D. Falls within JEDEC: 24/48 Pins MO-153

14/16/20/56 Pins – MO-194



D (R-PDSO-G14)

PLASTIC SMALL OUTLINE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0.006 (0,15) each side.
- Body width does not include interlead flash. Interlead flash shall not exceed 0.017 (0,43) each side.
- E. Reference JEDEC MS-012 variation AB.



PW (R-PDSO-G14)

PLASTIC SMALL OUTLINE



A. An integration of the information o

Body length does not include mold flash, protrusions, or gate burrs. Mold flash, protrusions, or gate burrs shall not exceed 0,15 each side.

Body width does not include interlead flash. Interlead flash shall not exceed 0,25 each side.

E. Falls within JEDEC MO-153



MECHANICAL DATA

MSSO002E - JANUARY 1995 - REVISED DECEMBER 2001

DB (R-PDSO-G**)

PLASTIC SMALL-OUTLINE

28 PINS SHOWN



NOTES: A. All linear dimensions are in millimeters.

- B. This drawing is subject to change without notice.
- C. Body dimensions do not include mold flash or protrusion not to exceed 0,15.
- D. Falls within JEDEC MO-150



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